



Docket No. 204552030600
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Nobuhiro NISHIYAMA et al.

Application No. 10/695,001

Confirmation No. 5307

Filed: October 29, 2003

Art Unit: 2828

For: SEMICONDUCTOR LASER ASSEMBLY

Examiner: Tuan N. Nguyen

RESPONSE UNDER 37 CFR 1.111

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Action dated August 3, 2006, please reconsider the claims in light of the following remarks.

REMARKS

Initially, applicants thank the Examiner for indicating that claims 11 and 12 contain allowable subject matter. Applicants have respectfully chosen to maintain claims 11 and 12 in their dependent form in light of the following remarks.

Claims 1-6 stand rejected under 35 USC 102(b) on Lebby (U.S. Patent No. 5,838,703). Applicants respectfully traverse this rejection.

Claim 1 recites a semiconductor laser assembly comprising "a substrate including a first mount surface and a second mount surface; a submount mounted on the first mount surface of the substrate; a laser diode mounted on the submount and having at least one light emission point and